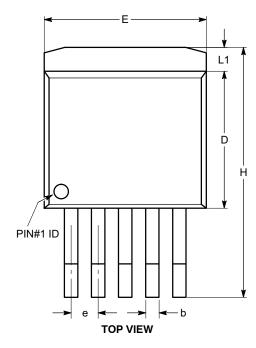
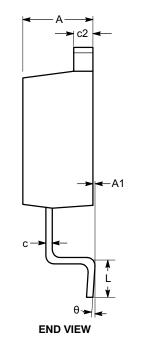
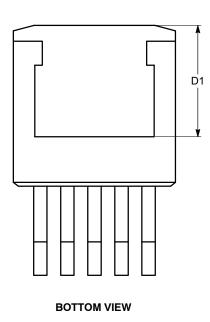


TO-263, 5 Lead CASE 221AE-01 ISSUE O

DATE 19 DEC 2008







| SYMBOL | MIN   | NOM      | MAX   |
|--------|-------|----------|-------|
| А      | 4.20  |          | 4.80  |
| A1     | 0.00  |          | 0.25  |
| b      | 0.60  |          | 0.88  |
| с      | 0.33  |          | 0.50  |
| c2     | 1.15  |          | 1.60  |
| D      | 8.40  |          | 9.60  |
| D1     | 6.86  |          |       |
| E      | 9.80  |          | 10.67 |
| e      |       | 1.70 BSC |       |
| Н      | 14.61 |          | 15.87 |
| L      | 1.78  |          | 2.79  |
| L1     |       |          | 1.67  |
| θ      | 0°    |          | 8°    |

## Notes:

- All dimensions are in millimeters. Angles in degrees.
  Complies with JEDEC standard TO-263.

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| REFERENCE:       |                           |  |             |
| DESCRIPTION:     | TO-263, 5 LEAD            |  | PAGE 1 OF 2 |





PAGE 2 OF 2

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